

**AMENDMENTS TO THE CLAIM**

Claim 4 (currently amended): Structure of a chip package for a digital photographic lens device having a lens device assembly, a flexible circuit board and a hard thin plate, said assembly includes a top housing, a lens in said top housing, a chip mounted under said top housing, said assembly being mounted on said flexible circuit board, said flexible circuit board being connected to a back panel of said digital photographic lens device and being mounted with said hard thin plate to provide supporting strength and insulation of a connection thereof, said hard thin plate being mounted on a bottom of said flexible circuit board, said flexible circuit board having electrically conductive connection points printed onto a combination continuation strap body so that said flexible circuit board is pre-fabricated and packed into a reel, facilitating production process, a surface of said flexible circuit board being a layout with flexible electrical connection circuit of related circuit. --